

- ★ Green Device Available
- ★ Super Low Gate Charge
- ★ Excellent Cdv/dt effect decline
- ★ Advanced high cell density Trench technology

Product Summary



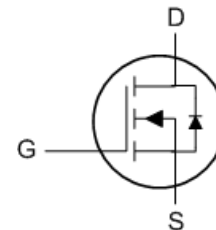
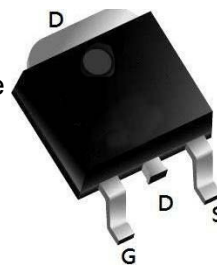
BVDSS	RDSON	ID
200V	450mΩ	5.5 A

Description

The XR5N20 is the high cell density trenched N-ch MOSFETs, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The XR5N20 meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

TO252-3L Pin Configuration



Absolute Maximum Ratings:

Symbol	Parameter	Value	Units
V_{DSS}	Drain-to-Source Voltage	200	V
I_D	Continuous Drain Current	5.5	A
I_{DM}^{a1}	Pulsed Drain Current	22	A
V_{GS}	Gate-to-Source Voltage	±20	V
P_D	Power Dissipation	30	W
T_J, T_{STG}	Operating Junction and Storage Temperature Range	150, -55 to 150	°C
T_L	Maximum Temperature for Soldering	260	°C

Thermal Characteristics:

Symbol	Parameter	Value	Units
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	4.17	°C/W

Electrical Characteristics (TA= 25°C unless otherwise specified):

Static Characteristics						
Symbol	Parameter	Test Conditions	Value			Units
			Min.	Typ.	Max.	
V _{DSS}	Drain to Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	200	--	--	V
I _{DSS}	Drain to Source Leakage Current	V _{DS} =200V, V _{GS} =0V	--	--	1	μA
I _{GSS(F)}	Gate to Source Forward Leakage	V _{GS} =+20V, V _{DS} =0V	--	--	100	nA
I _{GSS(R)}	Gate to Source Reverse Leakage	V _{GS} =-20V, V _{DS} =0V	--	--	-100	nA
V _{GS(TH)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	1	2	3	V
R _{DS(ON)}	Drain-to-Source On-Resistance	V _{GS} =10V, I _D =2A	--	450	550	mΩ

Dynamic Characteristics						
Symbol	Parameter	Test Conditions	Value			Units
			Min.	Typ.	Max.	
C _{iss}	Input Capacitance	V _{GS} = 0V V _{DS} = 100V f = 1.0MHz	--	461	--	pF
C _{oss}	Output Capacitance		--	11.6	--	
C _{rss}	Reverse Transfer Capacitance		--	8.5	--	
R _g	Gate resistance	V _{GS} =0V, V _{DS} Open	--	1.35	--	Ω

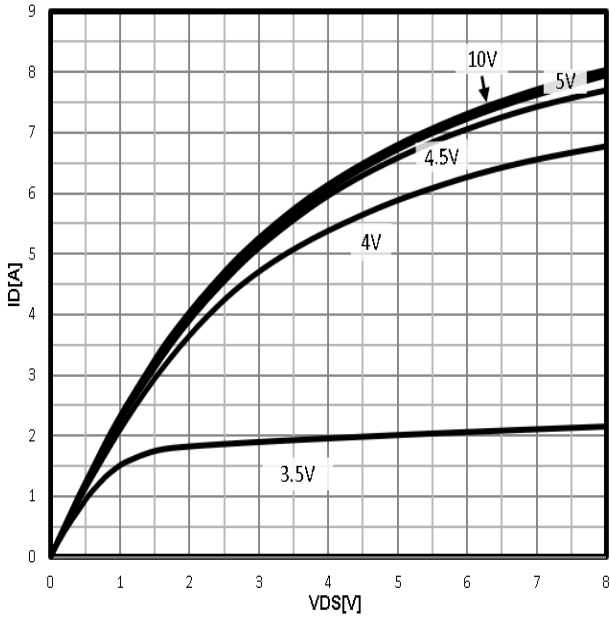
Resistive Switching Characteristics						
Symbol	Parameter	Test Conditions	Value			Units
			Min.	Typ.	Max.	
t _{d(ON)}	Turn-on Delay Time	I _D = 2A V _{DS} = 100V V _{GS} = 10V R _G = 4Ω	--	6	--	ns
t _r	Rise Time		--	7	--	
t _{d(OFF)}	Turn-Off Delay Time		--	17	--	
t _f	Fall Time		--	8	--	
Q _g	Total Gate Charge	V _{GS} = 10V V _{DS} = 100V I _D = 2A	--	11.4	--	nC
Q _{gs}	Gate Source Charge		--	1.75	--	
Q _{gd}	Gate Drain Charge		--	2.9	--	

Source-Drain Diode Characteristics						
Symbol	Parameter	Test Conditions	Value			Value
			Min.	Typ.	Max.	
I _S	Diode Forward Current	T _C = 25 °C	--	--	5.5	A
V _{SD}	Diode Forward Voltage	I _S =2A, V _{GS} =0V	--	--	1.2	V
t _{rr}	Reverse Recovery time	I _S =2A, V _{DD} =100V dI/dt=100A/μs	--	75	--	ns
Q _{rr}	Reverse Recovery Charge		--	198	--	nC

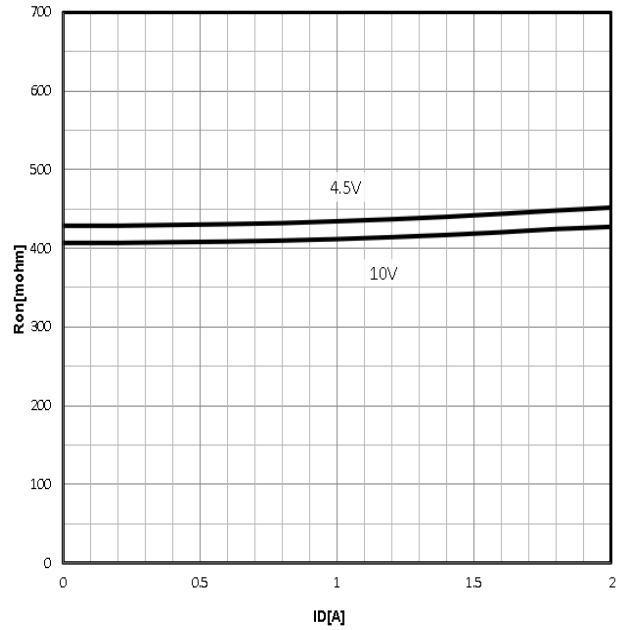
^{a1}: Repetitive rating; pulse width limited by maximum junction temperature

Characteristics Curve:

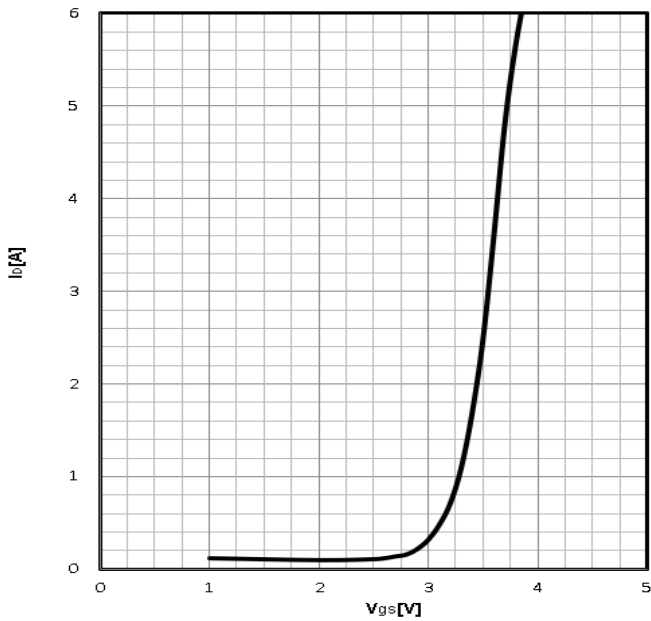
Typ. output characteristics
 $I_D = f(V_{DS})$



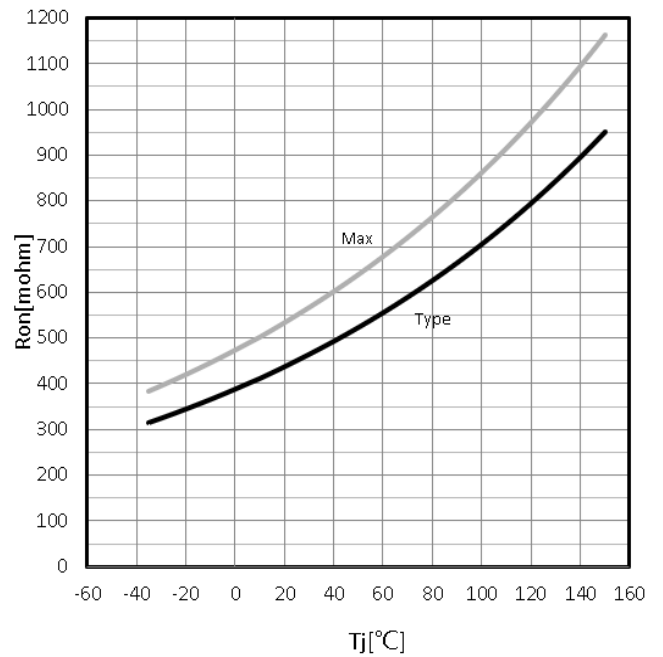
Typ. drain-source on resistance
 $R_{DS(on)} = f(I_D)$



Typ. transfer characteristics
 $I_D = f(V_{GS})$

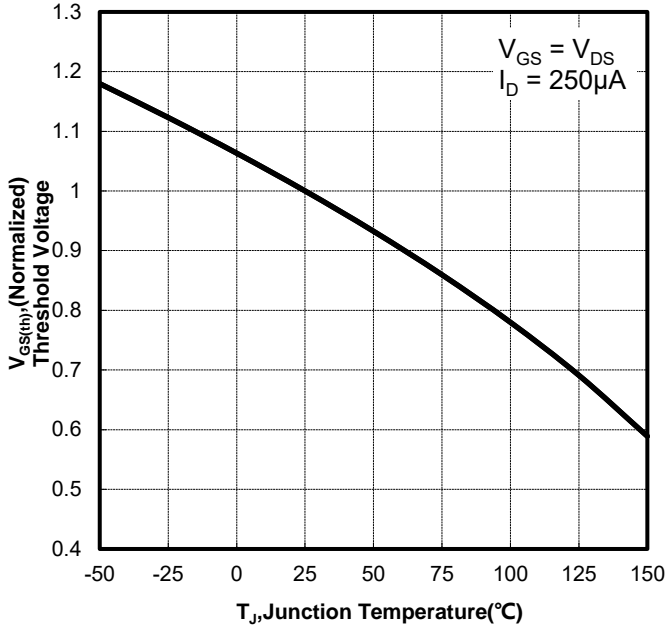


Drain-source on-state resistance
 $R_{DS(on)} = f(T_j); I_D = 2A; V_{GS} = 10V$



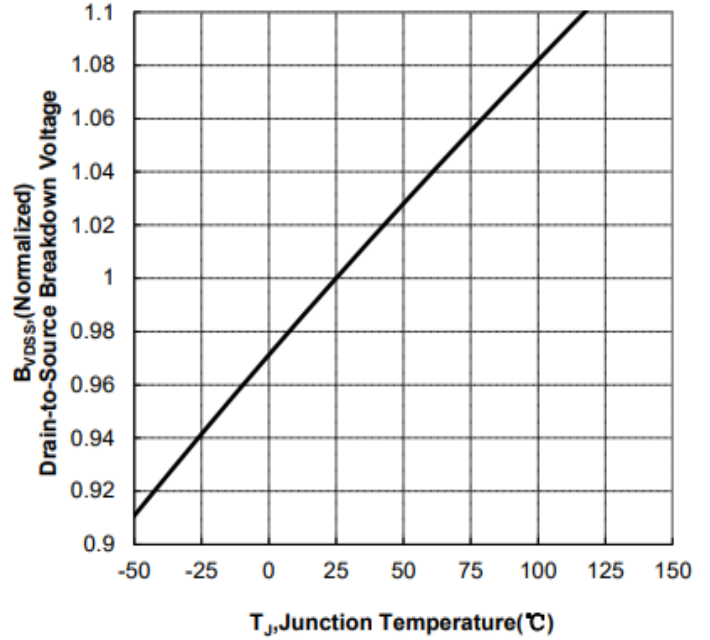
Gate Threshold Voltage

$$V_{TH} = f(T_j); I_D = 250\mu A$$



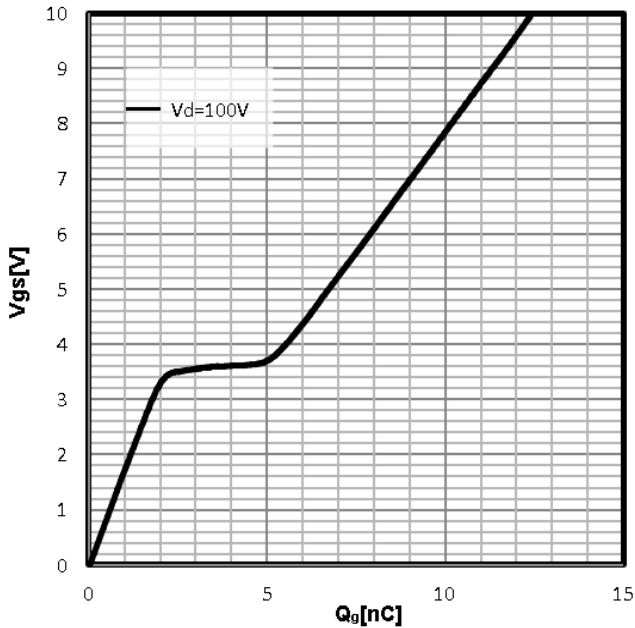
Drain-source breakdown voltage

$$V_{BR(DSS)} = f(T_j); I_D = 250\mu A$$



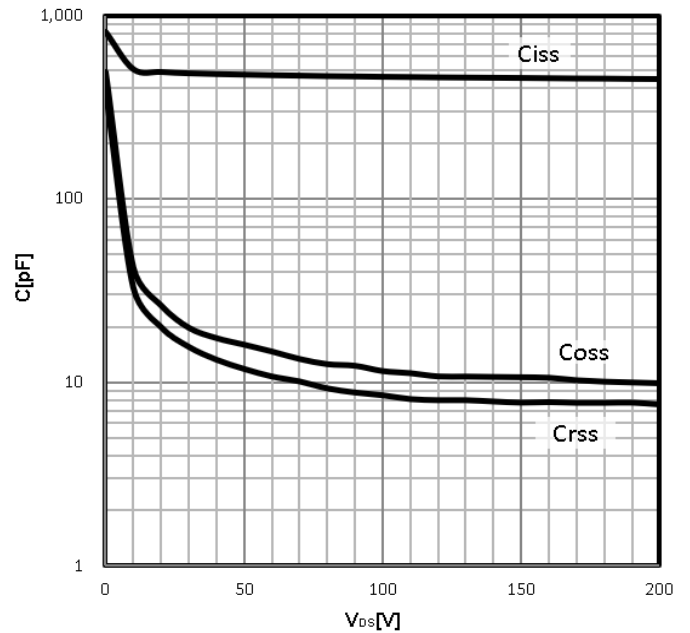
Typ. gate charge

$$V_{GS} = f(Q_g); I_D = 2A$$



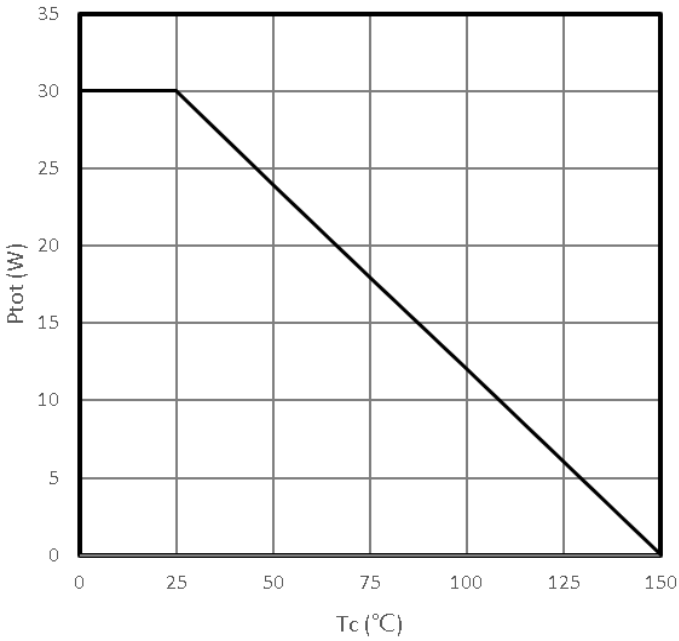
Typ. capacitances

$$C = f(V_{DS}); V_{GS} = 0V; f = 1MHz$$



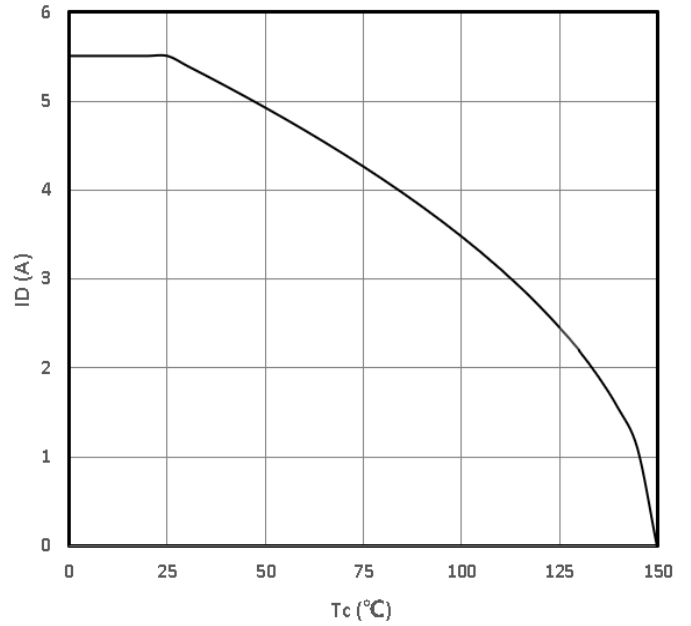
Power Dissipation

$$P_{tot}=f(T_c)$$



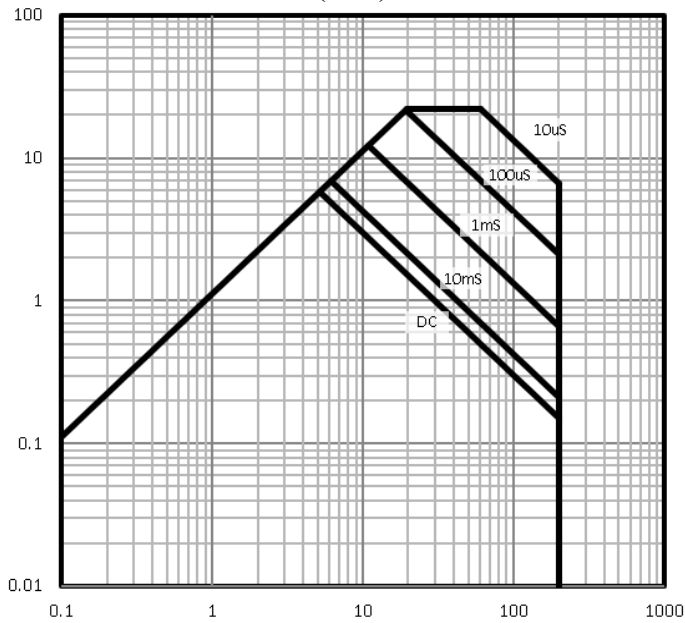
Maximum Drain Current

$$I_D=f(T_c)$$



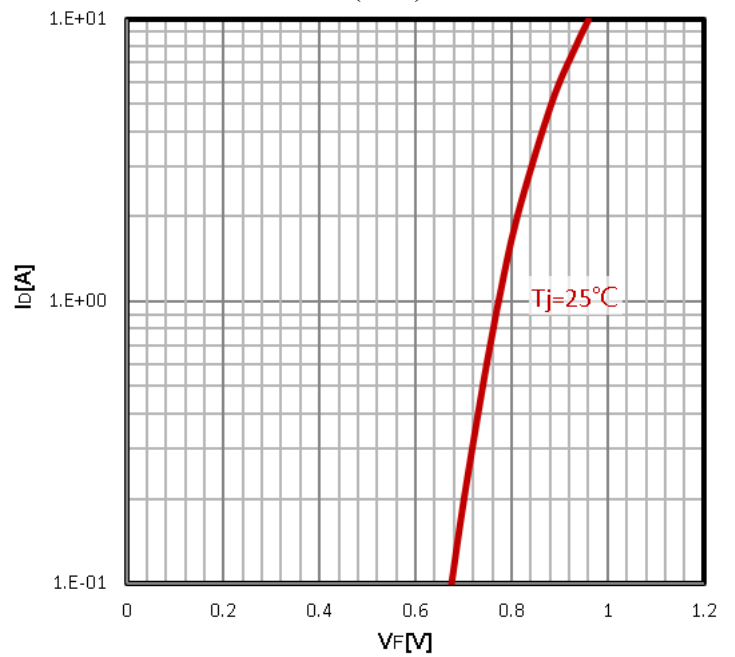
Safe operating area

$$I_D=f(V_{DS})$$



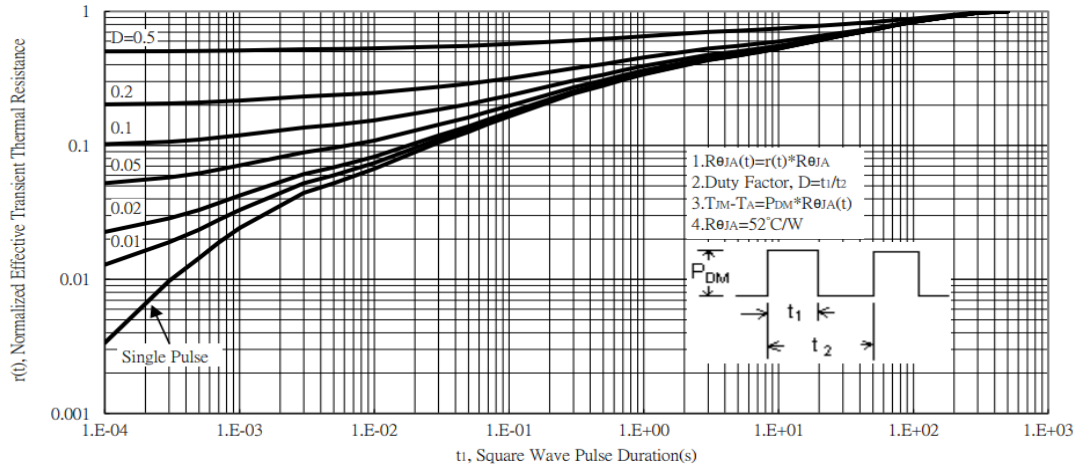
Body Diode Forward Voltage Variation

$$I_F=f(V_{GS})$$

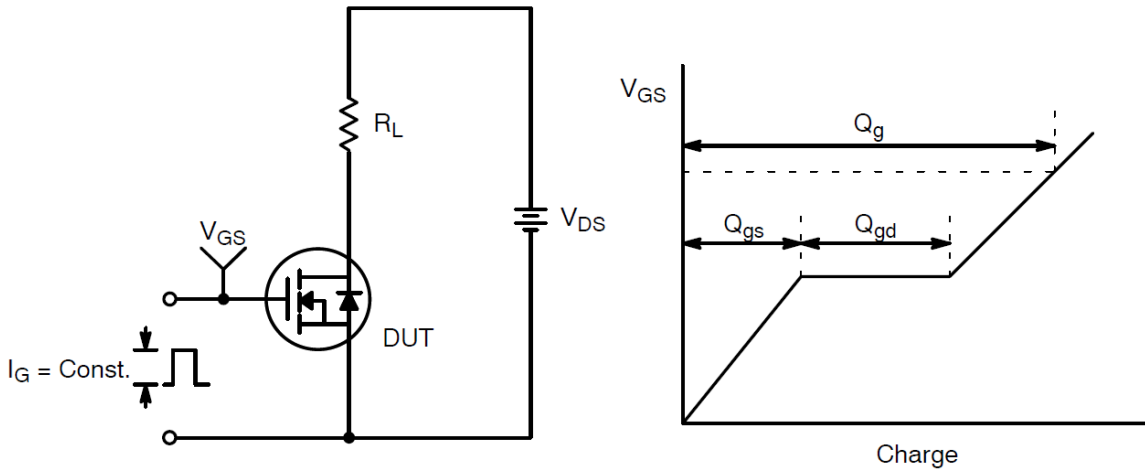


Max. transient thermal impedance

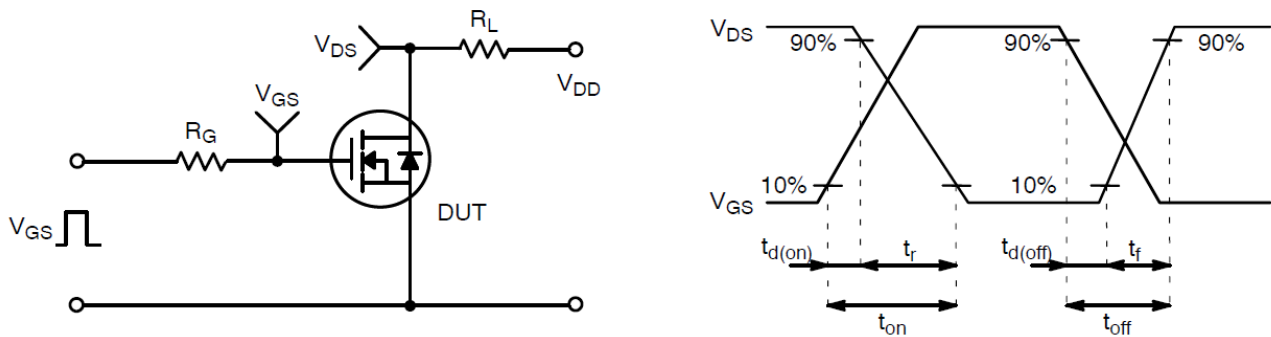
$$Z_{thJC} = f(t_p)$$



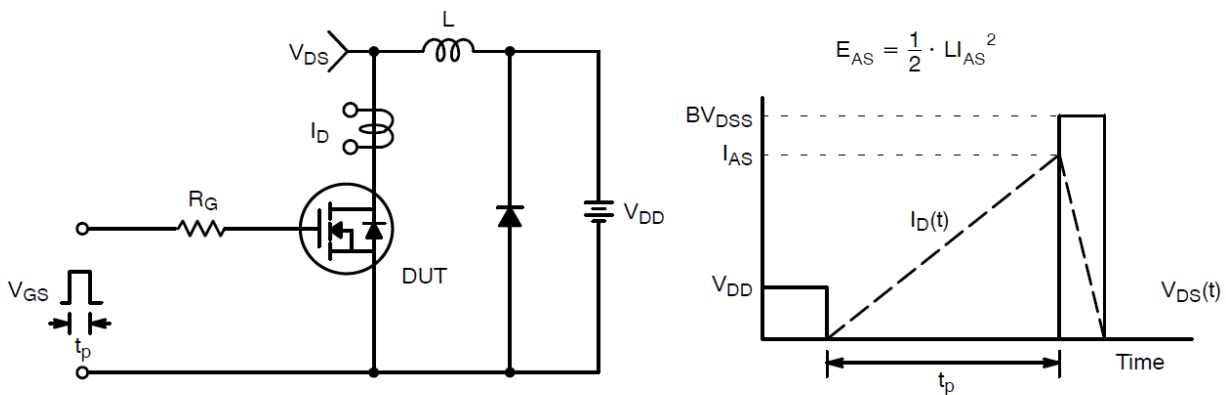
Test Circuit and Waveform:



Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms

